

Title (en)  
Heat dissipating device

Title (de)  
Wärmeableitungsvorrichtung

Title (fr)  
Dispositif de dissipation de chaleur

Publication  
**EP 2518401 A3 20121205 (EN)**

Application  
**EP 11179403 A 20110830**

Priority  
CN 201110110519 A 20110427

Abstract (en)  
[origin: EP2518401A2] A heat dissipating device includes a tubular body (2) having a first open end (211), and a plurality of heat dissipating fins (3), each having a fin body (31) and a first engaging portion (32) formed on the fin body (31) for engaging the first open end (211) of the tubular body (2) in a manner that the heat dissipating fins (3) are disposed to radiate from and to surround the tubular body (2). The first engaging portion (32) includes a first extension section (321) bent from the fin body (31), and a first hook (322) extending from the first extension section (321) for hooking onto the tubular body (2) at the first open end (211).

IPC 8 full level  
**F21V 29/00** (2006.01); **F28F 3/08** (2006.01)

CPC (source: EP US)  
**F21V 29/773** (2015.01 - EP US)

Citation (search report)

- [A] TW M395787 U 20110101 - HONG KUAN TECHNOLOGY CO LTD [TW]
- [A] WO 2011029724 A1 20110317 - OSRAM GMBH [DE], et al

Designated contracting state (EPC)  
AL AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO RS SE SI SK SM TR

Designated extension state (EPC)  
BA ME

DOCDB simple family (publication)  
**EP 2518401 A2 20121031; EP 2518401 A3 20121205**; CN 102760705 A 20121031; JP 2012235078 A 20121129; US 2012273180 A1 20121101

DOCDB simple family (application)  
**EP 11179403 A 20110830**; CN 201110110519 A 20110427; JP 2011177964 A 20110816; US 201113220159 A 20110829